

## **General Description**

The WSD4076DN56 is the highest performance trench N-Ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications. The WSD4076DN56 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

## **Features**

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

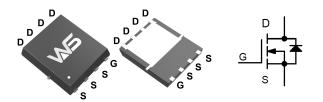
## **Product Summery**

BVDSS	RDSON	ID
40V	6.9mΩ	76A

# **Applications**

- High Frequency Point-of-Load Synchronous Buck Converter
- Networking DC-DC Power System
- Power Tool Application

## **DFN5X6-8L Pin Configuration**



## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage 40		V
$V_{GS}$	Gate-Source Voltage	±20	V
I <sub>D</sub> @T <sub>C</sub> =25℃	Continuous Drain Current, V <sub>GS</sub> @ 10V	76	Α
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V	А	
I <sub>DM</sub>	Pulsed Drain Current <sup>a</sup>	125	А
EAS	Single Pulse Avalanche Energy <sup>b</sup>	31	mJ
I <sub>AS</sub>	Avalanche Current 31		Α
P <sub>D</sub> @T <sub>a</sub> =25℃	Total Power Dissipation 1.7		W
T <sub>STG</sub>	Storage Temperature Range -55 to 150		$^{\circ}$
$T_J$	Operating Junction Temperature Range -55 to 150		$^{\circ}$

#### **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
$R_{ heta JA}$	Thermal Resistance Junction-Ambient <sup>1</sup>		85	°C/W
$R_{ heta JC}$	Thermal Resistance Junction-Case <sup>1</sup>		30	°C/W

Note a: Package is limited.

Note b: UIS tested and pulse width limited by maximum junction temperature 150°C (initial temperature Tj=25°C).



# Electrical Characteristics (T<sub>J</sub>=25 C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	40			V
$\triangle BV_{DSS}/\triangle T_{J}$	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =1mA		0.043		V/°C
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =12A		6.9	8.5	mΩ
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =4.5V , I <sub>D</sub> =10A		10	15	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	-V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	1.5	1.6	2.5	V
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	V <sub>GS</sub> -V <sub>DS</sub> , ID -250UA		-6.94		mV/℃
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =32V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			2	uA
IDSS		V <sub>DS</sub> =32V , V <sub>GS</sub> =0V , T <sub>J</sub> =55℃			10	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}$ = $\pm 20 V$ , $V_{DS}$ = $0 V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =20A		18		S
$R_g$	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		1.7		Ω
$Q_g$	Total Gate Charge (10V)			5.8	<b></b>	
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DS</sub> =20V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =12A		3.0		nC
$Q_{gd}$	Gate-Drain Charge			1.2		
T <sub>d(on)</sub>	Turn-On Delay Time	$V_{DD}$ =15V , $V_{GEN}$ =10V , $R_{G}$ =3.3 $\Omega$ , $I_{D}$ =1A .		12		
Tr	Rise Time			5.6		
T <sub>d(off)</sub>	Turn-Off Delay Time			20		ns
T <sub>f</sub>	Fall Time			11		
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		680		
C <sub>oss</sub>	Output Capacitance			185		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			38		

## **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current <sup>1,6</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			76	Α
I <sub>SM</sub>	Pulsed Source Current <sup>2,6</sup>	VG-VD-UV , FOICE Current			125	Α
$V_{SD}$	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25℃			1.2	V

- 1. The data tested by surface mounted on a 1 inch $^2$  FR-4 board with 2OZ copper,t<10sec .
- 2. The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2% 3. The EAS data shows Max. rating . The test condition is V<sub>DD</sub>=20V,V<sub>GS</sub>=10V,L=0.1mH,I<sub>AS</sub>=31A 4. The power dissipation is limited by 150°C junction temperature 5. The Min. value is 100% EAS tested guarantee.

- 6.The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.
- 7. Package limitation current is 60A.



# **Typical Characteristics**

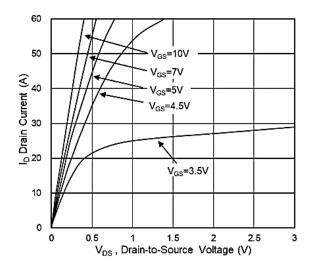


Fig.1 Typical Output Characteristics

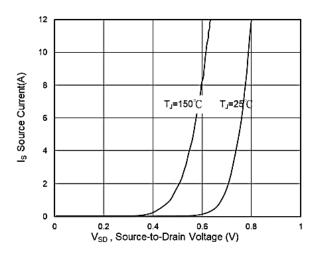


Fig.3 Source Drain Forward Characteristics

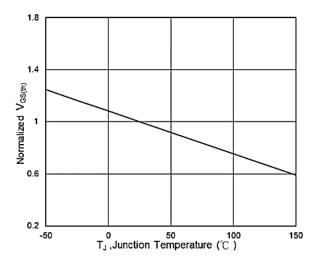


Fig.5 Normalized V<sub>GS(th)</sub> vs T<sub>J</sub>

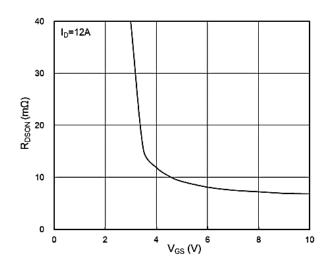


Fig.2 On-Resistance vs G-S Voltage

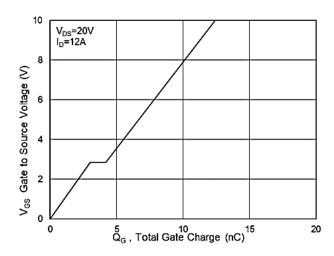


Fig.4 Gate-Charge Characteristics

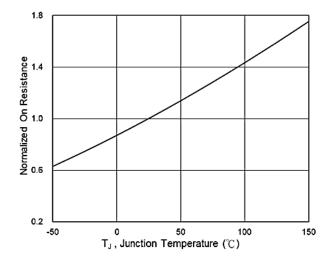


Fig.6 Normalized RDSON vs TJ



# **Typical Characteristics**

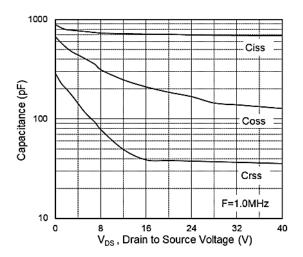


Fig.7 Capacitance

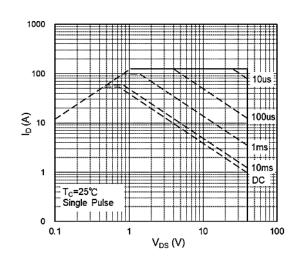


Fig.8 Safe Operating Area

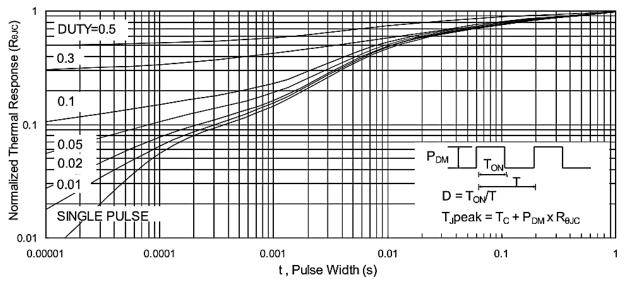


Fig.9 Normalized Maximum Transient Thermal Impedance

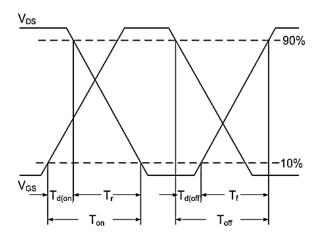


Fig.10 Switching Time Waveform

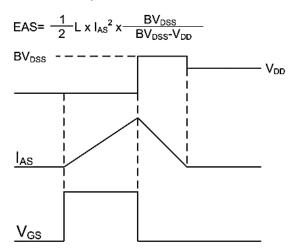


Fig.11 Unclamped Inductive Waveform



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